CMOSIC FROM 64K byte, RAM 2048 byte on-chip

8-bit 1-chip Microcontroller



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Overview

The LC87F5M64A is an 8-bit microcomputer that, integrates on a single chip a number of hardware features such as 64K-byte flash ROM, 2048-byte RAM, On-chip debugging function, a 16-bit timer/counter, four 8-bit timers, a base timer serving as a time-of-day clock, a high-speed clock counter, a synchronous SIO interface (with automatic block transmission/reception capabilities), an asynchronous/synchronous SIO port, two UART ports, an 11-channel AD converter, two 12-bit PWM channels, a system clock frequency divider, and an interrupt feature.

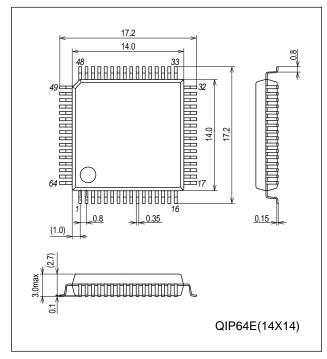
Features

- ■Flash ROM
 - 65536×8 bits
 - Capable of on-board-programing with wide range, 2.7 to 5.5V, of voltage source
 - Block-erasable in 128 byte units

- 2048×9 bits
- ■Package Form
- QIP64E (14 × 14): "Lead-free and halogen-free type"

Package Dimensions

unit: mm (typ) 3159A



* This product is licensed from Silicon Storage Technology, Inc. (USA).

■Minimum Bus Cycle Time

83.3ns (12MHz)
 125ns (8MHz)
 500ns (2MHz)
 VDD=2.8 to 5.5V
 VDD=2.5 to 5.5V
 VDD=2.2 to 5.5V

Note: The bus cycle time here refers to the ROM read speed.

■Minimum Instruction Cycle Time (tCYC)

 $\begin{array}{lll} \bullet \ 250 \text{ns} \ (12 \text{MHz}) & V_{DD} = 2.8 \ \text{to} \ 5.5 \text{V} \\ \bullet \ 375 \text{ns} \ (8 \text{MHz}) & V_{DD} = 2.5 \ \text{to} \ 5.5 \text{V} \\ \bullet \ 1.5 \mu \text{s} \ (2 \text{MHz}) & V_{DD} = 2.2 \ \text{to} \ 5.5 \text{V} \\ \end{array}$

■Ports

• Normal withstand voltage I/O ports

Ports whose I/O direction can be designated in 1-bit units 46 (P1n, P2n, P3n, P70 to P73, P80 to P86, PCn,

PWM2, PWM3, XT2)

8 (P0n)

Ports whose I/O direction can be designated in 4-bit units

Normal withstand voltage input port
 Dedicated oscillator ports
 Reset pins
 1 (XT1)
 2 (<u>CF1</u>, CF2)
 1 (RES)

• Power pins 6 (Vss1 to 3, Vpp1 to 3)

■Timers

• Timer 0: 16-bit timer/counter with a capture register

Mode 0: 8-bit timer with an 8-bit programmable prescaler (with an 8-bit capture register) ×2 channels

Mode 1: 8-bit timer with an 8-bit programmable prescaler (with an 8-bit capture register)

+ 8-bit counter (with an 8-bit capture register)

Mode 2: 16-bit timer with an 8-bit programmable prescaler (with a 16-bit capture register)

Mode 3: 16-bit counter (with a 16-bit capture register)

• Timer 1: 16-bit timer/counter that supports PWM/toggle outputs

 $Mode\ 0:\ 8\text{-bit timer with an }8\text{-bit prescaler (with toggle outputs)} + 8\text{-bit timer/counter}$

with an 8-bit prescaler (with toggle outputs)

Mode 1: 8-bit PWM with an 8-bit prescaler × 2 channels

Mode 2: 16-bit timer/counter with an 8-bit prescaler (with toggle outputs)

(toggle outputs also possible from the lower-order 8-bits)

Mode 3: 16-bit timer with an 8-bit prescaler (with toggle outputs) (The lower-order 8 bits can be used as PWM)

- Timer 4: 8-bit timer with a 6-bit prescaler
- Timer 5: 8-bit timer with a 6-bit prescaler
- Timer 6: 8-bit timer with a 6-bit prescaler (with toggle outputs)
- Timer 7: 8-bit timer with a 6-bit prescaler (with toggle outputs)
- Base timer
 - 1) The clock is selectable from the subclock (32.768kHz crystal oscillation), system clock, and timer 0 prescaler output.
 - 2) Interrupts programmable in 5 different time schemes.

■High-speed Clock Counter

- 1) Can count clocks with a maximum clock rate of 24MHz (at a main clock of 12MHz)
- 2) Can generate output real-time.

■SIO

- SIO0: 8-bit synchronous serial interface
 - 1) LSB first/MSB first mode selectable
 - 2) Built-in 8-bit baudrate generator (maximum transfer clock cycle = 4/3 tCYC)
 - 3) Automatic continuous data transmission (1 to 256 bits, specifiable in 1 bit units, suspension and resumption of data transmission possible in 1 byte units)
- SIO1: 8-bit asynchronous/synchronous serial interface
 - Mode 0: Synchronous 8-bit serial I/O (2- or 3-wire configuration, 2 to 512 tCYC transfer clocks)
 - Mode 1: Asynchronous serial I/O (half-duplex, 8 data bits, 1 stop bit, 8 to 2048 tCYC baudrates)
 - Mode 2: Bus mode 1 (start bit, 8 data bits, 2 to 512 tCYC transfer clocks)
 - Mode 3: Bus mode 2 (start detect, 8 data bits, stop detect)

■UART: 2 channels

- Full duplex
- 7/8/9 bit data bits selectable
- 1 stop bit (2 bit in continuous data transmission)
- Built-in baudrate generator (with baudrates of 16/3 to 8192/3 tCYC)

■AD Converter: 8 bits × 11 channels

- ■PWM: Multifrequency 12-bit PWM × 2 channels
- ■Remote Control Receiver Circuit (sharing pins with P73, INT3, and T0IN)
 - 1) Noise filtering function (noise filter time constant selectable from 1 tCYC, 32 tCYC, and 128 tCYC)
 - 2) The noise filtering function is available for the INT3, T0IN, or T0HCP signal at P73. When P73 is read with an instruction, the signal level at that pin is read regardless of the availability of the noise filtering function.

■Watchdog Timer

- External RC watchdog timer
- Interrupt and reset signals selectable

■Clock Output Function

- 1) Able to output selected oscillation clock 1/1, 1/2, 1/4, 1/8, 1/16, 1/32, 1/64 as system clock.
- 2) Able to output oscillation clock of sub clock.

■Interrupts

- 27 sources. 10 vector addresses
 - 1) Provides three levels (low (L), high (H), and highest (X)) of multiplex interrupt control. Any interrupt requests of the level equal to or lower than the current interrupt are not accepted.
 - 2) When interrupt requests to two or more vector addresses occur at the same time, the interrupt of the highest level takes precedence over the other interrupts. For interrupts of the same level, the interrupt into the smallest vector address takes precedence.

No.	Vector Address	Level	Interrupt Source		
1	00003H	X or L	INT0		
2	0000BH	X or L	INT1		
3	00013H	H or L	INT2/T0L/INT4		
4	0001BH	H or L	INT3/INT5/base timer0/base timer1		
5	00023H	H or L	T0H/INT6		
6	0002BH	H or L	T1L/T1H/INT7		
7	00033H	H or L	SIO0/UART1 receive/UART2 receive		
8	0003BH	H or L	SIO1/UART1 transmit/UART2 transmit		
9	00043H	H or L	ADC/T6/T7		
10	0004BH	H or L	Port 0/T4/T5/PWM2, PWM3		

- Priority levels X > H > L
- Of interrupts of the same level, the one with the smallest vector address takes precedence.
- ■Subroutine Stack Levels: 1024 levels (the stack is allocated in RAM)

■High-speed Multiplication/Division Instructions

• 16-bits \times 8-bits (5 tCYC execution time)

• 24-bits × 16-bits (12 tCYC execution time)

• 16-bits ÷ 8-bits (8 tCYC execution time)

• 24-bits ÷ 16-bits (12 tCYC execution time)

■Oscillation Circuits

• RC oscillation circuit (internal) : For system clock

CF oscillation circuit
 Crystal oscillation circuit
 For system clock, with internal Rf
 For low-speed system clock

• Multifrequency RC oscillation circuit (internal) : For system clock

■System Clock Divider Function

- Can run on low current.
- The minimum instruction cycle selectable from 250ns, 500ns, 1.0μs, 2.0μs, 4.0μs, 8.0μs, 16.0μs, 32.0μs, and 64.0μs (at a main clock rate of 12MHz).

■Standby Function

- HALT mode: Halts instruction execution while allowing the peripheral circuits to continue operation.
 - 1) Oscillation is not halted automatically.
 - 2) Canceled by a system reset or occurrence of an interrupt.
- HOLD mode: Suspends instruction execution and the operation of the peripheral circuits.
 - 1) The CF, RC, and crystal oscillators automatically stop operation.
 - 2) There are three ways of resetting the HOLD mode.
 - (1) Setting the reset pin to the lower level.
 - (2) Setting at least one of the INT0, INT1, INT2, INT4, and INT5 pins to the specified level
 - (3) Having an interrupt source established at port 0
- X'tal HOLD mode: Suspends instruction execution and the operation of the peripheral circuits except the base timer.
 - 1) The CF and RC oscillators automatically stop operation.
 - 2) The state of crystal oscillation established when the X'tal HOLD mode is entered is retained.
 - 3) There are four ways of resetting the X'tal HOLD mode.
 - (1) Setting the reset pin to the low level
 - (2) Setting at least one of the INT0, INT1, INT2, INT4, and INT5 pins to the specified level
 - (3) Having an interrupt source established at port 0
 - (4) Having an interrupt source established in the base timer circuit

■On-chip Debugger Function

• Permits software debugging with the test device installed on the target board.

■Development Tools

• Evaluation (EVA) chip : LC87EV690

• Emulator : EVA62S + ECB876600D + SUB875M00 + POD64QFP

ICE-B877300 + SUB875M00 + POD64QFP

• On-chip-debugger : TCB87-TypeB + LC87F5M64A

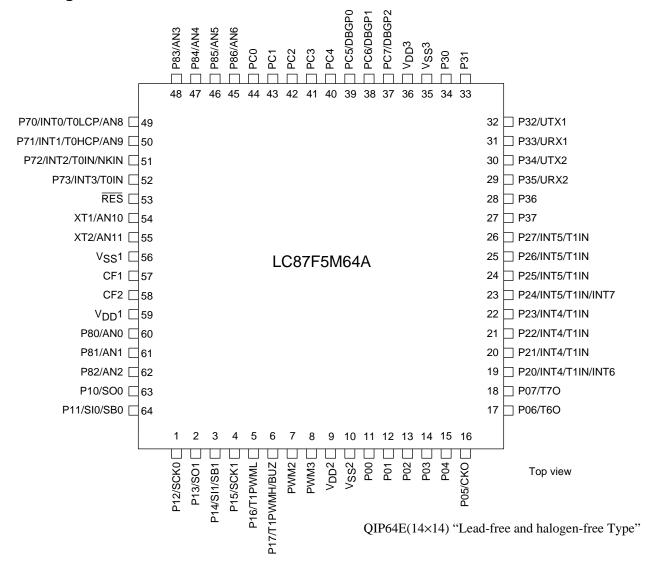
■Programming Boards

Package	Programming boards
QIP64E(14 × 14)	W87F50256Q

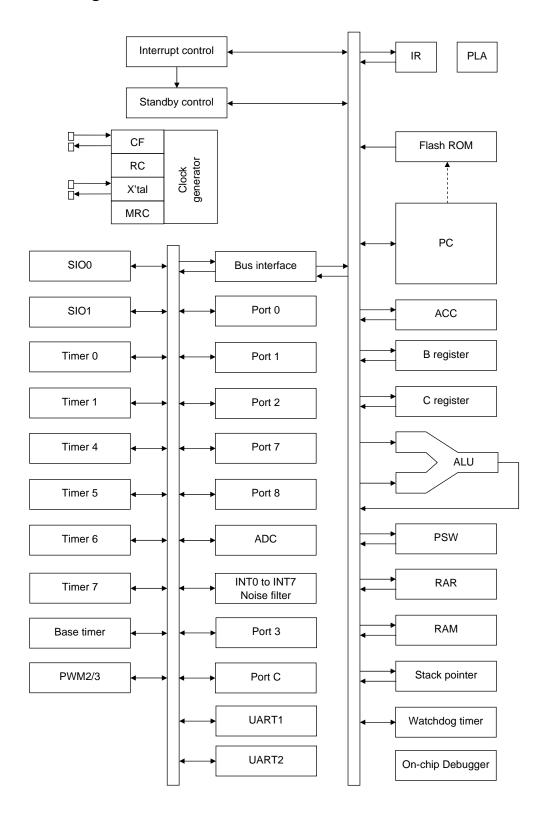
■Flash ROM Programmer

Maker	Model	Support version(Note)	Device
Flash Support Group, Inc.(Single)	AF9708/09/09B (including product of Ando Electric Co.,Ltd)	Revision : After Rev.02.73	LC87F6D64A
Flash Support	AF9723(Main body) (including product of Ando Electric Co.,Ltd)	Revision : After Rev.02.29	LC87F5M64A
Group, Inc.(Gang)	AF9833(Unit) (including product of Ando Electric Co.,Ltd)	Revision : After Rev.01.88	LC87F5IVI64A
Our company	SKK/SKK Type-B/SKK DBG Type-B (SANYO FWS)	Application Version: After 1.04 Chip Data Version: After2.10	LC87F5M64A

Pin Assignment



System Block Diagram



Pin Description

Pin Name	I/O			Des	scription			Option		
V _{SS} 1, V _{SS} 2	-	- Power supply	oin		1			No		
V _{SS} 3										
V _{DD} 1, V _{DD} 2	-	+ Power supply	pin					No		
V_{DD3}										
Port 0	I/O	• 8-bit I/O port						Yes		
P00 to P07	1	I/O specifiable	in 4-bit units							
1 00 10 1 07		Pull-up resistor	r can be turned	on and off in 4-bi	it units					
		HOLD release	input							
		Port 0 interrupt	t input							
		 Shared Pins 								
		P05: Clock out	put (system clod	k/can selected f	rom sub clock)					
		P06: Timer 6 to	Timer 6 toggle output							
		P07: Timer 7 to	oggle output							
Port 1	I/O	• 8-bit I/O port						Yes		
P10 to P17	1	I/O specifiable	in 1-bit units							
		Pull-up resistor	r can be turned	on and off in 1-bi	it units					
		Pin functions								
		P10: SIO0 data	a output							
		P11: SIO0 data	a input/bus I/O							
		P12: SIO0 cloc	ck I/O							
		P13: SIO1 data	a output							
		P14: SIO1 data	•							
		P15: SIO1 cloc								
		P16: Timer 1 F	•							
			PWMH output/be	eper output						
Port 2	I/O	8-bit I/O port						Yes		
P20 to P27		I/O specifiable								
		Pull-up resistor		on and off in 1-bi	t units					
		Other functions								
		•		put/timer 1 even	-					
				T6 input/timer 0l			.,			
			•	reset input/timer	1 event input/tin	ner 0L capture ir	nput/			
			capture input							
		· ·		put/timer 1 even	-					
				T7 input/timer 0						
			•	reset input/timer	i eveni input/iiii	ner or capture ir	ipui/			
			timer 0H capture input nterrupt acknowledge type							
		Interrupt acknowledge	owieuge type		Dining/	1				
			Rising	Falling	Rising/ Falling	H level	L level			
		INT4	enable	enable	enable	disable	disable			
		INT5	enable	enable	enable	disable	disable			
		1 1						1		
		INT6	enable	enable	enable	disable	disable			

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Pin Name	I/O		Des	scription			Option		
Port 7	I/O	• 4-bit I/O port					No		
P70 to P73		I/O specifiable in 1-bit units							
		Pull-up resistor can be turned on and off in 1-bit units							
		Shared Pins							
		P70: INT0 input/HOLD reset input	timer 0L cap	ture input/watcho	log timer output				
		P71: INT1 input/HOLD reset input	timer 0H cap	ture input					
		P72: INT2 input/HOLD reset input	timer 0 even	t input/timer 0L c	apture input/				
		high speed clock counter inp	out						
		P73: INT3 input (with noise filter)/	timer 0 event	input/timer 0H ca	apture input				
		AD converter input port: AN8 (P70), AN9 (P71)						
		Interrupt acknowledge type							
		Diging	Falling	Rising/	Hayel	Llovel			
		Rising	Falling	Falling	H level	L level			
		INT0 enable	enable	disable	enable	enable			
		INT1 enable	enable	disable	enable	enable			
		INT2 enable	enable	enable	disable	disable			
		INT3 enable	enable	enable	disable	disable			
						_			
Port 8	I/O	• 7-bit I/O port					No		
P80 to P86		• I/O specifiable in 1-bit units							
		Shared Pins							
		AD converter input port : AN0 (P8	0) to AN6 (P8	36)					
PWM2	I/O	PWM2 and PWM3 output ports					No		
PWM3		General-purpose I/O available							
Port 3	I/O	• 8-bit I/O port					Yes		
P30 to P37		• I/O specifiable in 1-bit units							
		• Pull-up resistor can be turned on a	and off in 1-bi	t units					
		• Pin functions							
		P32: UART1 transmit							
		P33: UART1 receive							
		P34: UART2 transmit							
		P35: UART2 receive							
Port C	I/O	• 8-bit I/O port					Yes		
PC0 to PC7		• I/O specifiable in 1-bit units							
		• Pull-up resistor can be turned on a	and off in 1-bi	t units					
		Pin functions							
		DBGP0 to DBGP2(PC5 to PC7): 0	On-chip Debu	igger					
RES	Input	Reset pin					No		
XT1	Input	• 32.768kHz crystal oscillator input	pin				No		
		Shared pins							
		General-purpose input port							
		AD converter input port : AN10							
		Must be connected to V _{DD} 1 if not	to be used.						
XT2	I/O	32.768kHz crystal oscillator input	pin				No		
		Shared pins	-						
		General-purpose I/O port							
		AD converter input port : AN11							
		Must be set for oscillation and kep	ot open if not	to be used.					
CF1	Input	Ceramic resonator input pin					No		
CF2	Output	Ceramic resonator output pin					No		

Port Output Types

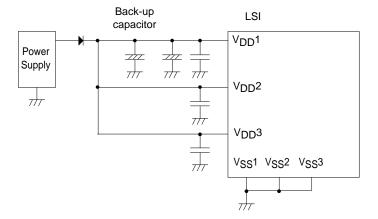
The table below lists the types of port outputs and the presence/absence of a pull-up resistor. Data can be read into any input port even if it is in the output mode.

Port Name	Options Selected in Units of	Option Type	Output Type	Pull-up Resistor
P00 to P07	1 bit	1	CMOS	Programmable (Note 1)
		2	Nch-open drain	No
P10 to P17	1 bit	1	CMOS	Programmable
		2	Nch-open drain	Programmable
P20 to P27	1 bit	1	CMOS	Programmable
		2	Nch-open drain	Programmable
P70	-	No	Nch-open drain	Programmable
P71 to P73	-	No	CMOS	Programmable
P80 to P86	-	No	Nch-open drain	No
PWM2, PWM3	-	No	CMOS	No
P30 to P37	1 bit	1	CMOS	Programmable
		2	Nch-open drain	Programmable
PC0 to PC7	1 bit	1	CMOS	Programmable
		2	Nch-open drain	Programmable
XT1	-	No	Input for 32.768kHz crystal oscillator (Input only)	No
XT2	-	No	Output for 32.768kHz crystal oscillator (Nch-open drain when in general-purpose output mode)	No

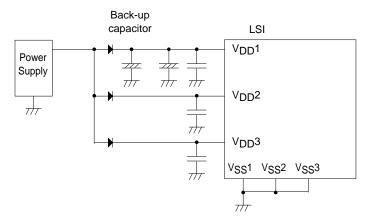
Note 1: Programmable pull-up resistors for port 0 are controlled in 4-bit units (P00 to 03, P04 to 07).

*1: Make the following connection to minimize the noise input to the $V_{DD}1$ pin and prolong the backup time. Be sure to electrically short the $V_{SS}1$, $V_{SS}2$, and $V_{SS}3$ pins.

(Example 1) When backup is active in the HOLD mode, the high level of the port outputs is supplied by the backup capacitors.



(Example 2) The high-level output at the ports is unstable when the HOLD mode backup is in effect.



Absolute Maximum Ratings at $Ta=25^{\circ}C,\,V_{SS}1=V_{SS}2=V_{SS}3=0V$

Parameter		Symbol	Pins/Remarks	Conditions		ı	Speci	fication	
N 4 -			V 4 V 0 V 0	V 4 V 0 V 0	V _{DD} [V]	min	typ	max	unit
	ximum supply tage	V _{DD} max	V _{DD} 1, V _{DD} 2, V _{DD} 3	V _{DD} 1=V _{DD} 2=V _{DD} 3		-0.3		+6.5	
Inp	ut voltage	V _I (1)	XT1, CF1			-0.3		V _{DD} +0.3	
Inp	ut/Output voltage	V _{IO} (1)	Ports 0, 1, 2						V
			Ports 7, 8 Ports 3, C			-0.3		V _{DD} +0.3	
			PWM2, PWM3, XT2						
	Peak output	IOPH(1)	Ports 0, 1, 2	CMOS output select		-10			
	current		Ports 3, C	Per 1 application pin		10			
		IOPH(2)	PWM2, PWM3	Per 1 application pin.		-20			
-		IOPH(3)	P71 to P73	Per 1 application pin.		-5			
	Mean output current	IOMH(1)	Ports 0, 1, 2 Ports 3, C	CMOS output select Per 1 application pin		-7.5			
rent	(Note1-1)	IOMH(2)	PWM2, PWM3	Per 1 application pin		-10			
ıt cur	,	IOMH(3)	P71 to P73	Per 1 application pin		-3			
utbn	Total output	ΣΙΟΑΗ(1)	P71 to P73	Total of all applicable pins		-10			
High level output current	current	ΣΙΟΑΗ(2)	Ports, 1	Total of all applicable pins					
jh le			PWM2, PWM3			-25			
Ξ̈́		ΣΙΟΑΗ(3)	Ports 0, 2	Total of all applicable pins		-25			
		ΣΙΟΑΗ(4)	Ports 0, 1, 2 PWM2, PWM3	Total of all applicable pins		-45			
		ΣΙΟΑΗ(5)	Port 3	Total of all applicable pins		-25			
		ΣΙΟΑΗ(6)	Ports C	Total of all applicable pins		-25			
		ΣΙΟΑΗ(7)	Ports 3, C	Total of all applicable pins		-45			
	Peak output	IOPL(1)	P02 to P07	Per 1 application pin					
	current		Ports 1, 2					20	
			Ports 3, C PWM2, PWM3						mA
		IOPL(2)	P00, P01	Per 1 application pin				30	IIIA
		IOPL(3)	Ports 7, 8, XT2	Per 1 application pin				10	
	Mean output	IOML(1)	P02 to P07	Per 1 application pin				10	
	current	- ()	Ports 1, 2	,,,,				15	
	(Note1-1)		Ports 3, C					15	
urrent		10141 (0)	PWM2, PWM3	B. A F f					
ıt cui		IOML(2)	P00, P01	Per 1 application pin				20	
nubr	Total autout	IOML(3)	Ports 7, 8, XT2	Per 1 application pin				7.5	
vel c	Total output current	ΣIOAL(1)	Port 7 P83 to P86, XT2	Total of all applicable pins				15	
Low level output c	ou.rom	ΣIOAL(2)	P80 to P82	Total of all applicable pins				15	
Ľ		ΣIOAL(3)	Ports 7, 8, XT2	Total of all applicable pins				20	
		ΣIOAL(4)	Ports 1 PWM2, PWM3	Total of all applicable pins				45	
		ΣIOAL(5)	Ports 0, 2	Total of all applicable pins				45	
		ΣIOAL(6)	Ports 0, 1, 2 PWM2, PWM3	Total of all applicable pins				80	
		ΣIOAL(7)	Port 3	Total of all applicable pins				45	
		ΣIOAL(8)	Ports C	Total of all applicable pins				45	
		ΣIOAL(9)	Ports 3, C	Total of all applicable pins				80	
	ximum power	Pd max	QIP64E(14×14)	Ta=-40 to +85°C				300	mW
Ор	erating ambient	Topr				-40		+85	
	orage ambient	Tstg						105	°C
ten	nperature				<u> </u>	-55		+125	

Note 1-1: The mean output current is a mean value measured over 100ms.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

 $\textbf{Allowable Operating Conditions} \ \, at \ \, Ta = -40^{\circ}C \ \, to \ \, +85^{\circ}C, \ \, V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

Doromotor	Cumbal	Dina/Damarka	Conditions			Specification		
Parameter	Symbol	Pins/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit
Operating	V _{DD} (1)	$V_{DD}1=V_{DD}2=V_{DD}3$	0.245μs≤ tCYC≤200μs		2.8		5.5	
supply voltage			0.367μs≤ tCYC≤200μs		2.5		5.5	
(Note2-1)			1.47μs≤ tCYC≤200μs		2.2		5.5	
Memory sustaining supply voltage	VHD	V _{DD} 1=V _{DD} 2=V _{DD} 3	RAM and register contents sustained in HOLD mode		2.0		5.5	
High level input voltage	V _{IH} (1)	Ports 1, 2 P71 to P73 P70 port input/ interrupt side		2.2 to 5.5	0.3V _{DD} +0.7		V _{DD}	
	V _{IH} (2)	Ports 0, 8, 3, C PWM2, PWM3		2.2 to 5.5	0.3V _{DD} +0.7		V _{DD}	
	V _{IH} (3)	P70 watchdog timer side		2.2 to 5.5	0.9V _{DD}		V _{DD}	V
	V _{IH} (4)	XT1, XT2, CF1, RES		2.2 to 5.5	0.75V _{DD}		V_{DD}	
Low level input voltage	V _{IL} (1)	Ports 1, 2 P71 to P73		4.0 to 5.5	V _{SS}		0.1V _{DD} +0.4	
		P70 port input/ Interrupt side		2.2 to 4.0	V _{SS}		0.2V _{DD}	
	V _{IL} (2)	Ports 0, 8, 3, C PWM2, PWM3		4.0 to 5.5	V _{SS}		0.15V _{DD} +0.4	
				2.2 to 4.0	V _{SS}		0.2V _{DD}	
	V _{IL} (3)	Port 70 watchdog timer side		2.2 to 5.5	V _{SS}		0.8V _{DD} -1.0	
	V _{IL} (4)	XT1, XT2, CF1, RES		2.2 to 5.5	V _{SS}		0.25V _{DD}	
Instruction cycle	tCYC			2.8 to 5.5	0.245		200	
time				2.5 to 5.5	0.367		200	μs
(Note2-2)				2.2 to 5.5	1.47		200	
External system	FEXCF(1)	CF1	CF2 pin open	2.8 to 5.5	0.1		12	
clock frequency			System clock frequency	2.5 to 5.5	0.1		8	
			division rate=1/1 • External system clock duty=50±5%	2.2 to 5.5	0.1		2	MHz
			CF2 pin open	2.8 to 5.5	0.2		24.4	
			System clock frequency	2.5 to 5.5	0.1		16	
			division rate=1/2	2.2 to 5.5	0.1		4	
Oscillation frequency	FmCF(1)	CF1, CF2	12MHz ceramic oscillation See Fig. 1.	2.8 to 5.5		12		
range (Note2-3)	FmCF(2)	CF1, CF2	8MHz ceramic oscillation See Fig. 1.	2.5 to 5.5		8		
	FmCF(3)	CF1, CF2	4MHz ceramic oscillation See Fig. 1.	2.2 to 5.5		4		MHz
	FmRC		Internal RC oscillation	2.2 to 5.5	0.3	1.0	2.0	
	FmMRC		Frequency variable RC oscillation	2.5 to 5.5		16		
	FsX'tal	XT1, XT2	32.768kHz crystal oscillation See Fig. 2.	2.2 to 5.5		32.768		kHz

Note 2-1: V_{DD} must be held greater than or equal to 2.7V in the flash ROM onboard programming mode.

Note 2-3: See Tables 1 and 2 for the oscillation constants.

Note 2-2: Relationship between tCYC and oscillation frequency is 3/FmCF at a division ratio of 1/1 and 6/FmCF at a division ratio of 1/2.

Parameter	Symbol	Pins/Remarks	Conditions			Specific	ation	ı
, arameter	5,111001		Conditions	V _{DD} [V]	min	typ	max	unit
High level input current	I _{IH} (1)	Ports 0, 1, 2 Ports 7, 8 Ports 3, C RES PWM2, PWM3	Output disabled Pull-up resistor off VIN=VDD (Including output Tr's off leakage current))	2.2 to 5.5			1	
	I _{IH} (2)	XT1, XT2	For input port specification VIN=VDD	2.2 to 5.5			1	
	I _{IH} (3)	CF1	V _{IN} =V _{DD}	2.2 to 5.5			15	
Low level input current	I _{IL} (1)	Ports 0, 1, 2 Ports 7, 8 Ports 3, C RES PWM2, PWM3	Output disabled Pull-up resistor off VIN=VSS (Including output Tr's off leakage current))	2.2 to 5.5	-1			μА
	I _{IL} (2)	XT1, XT2	For input port specification VIN=VSS	2.2 to 5.5	-1			
	I _{IL} (3)	CF1	V _{IN} =V _{SS}	2.2 to 5.5	-15			
High level output	V _{OH} (1)	Ports 0, 1, 2	I _{OH} =-1mA	4.5 to 5.5	V _{DD} -1			
voltage	V _{OH} (2)	Ports 3, C	I _{OH} =-0.4mA	3.0 to 5.5	V _{DD} -0.4			
	V _{OH} (3)		I _{OH} =-0.2mA	2.2 to 5.5	V _{DD} -0.4			
	V _{OH} (4)	Ports 71 to 73	I _{OH} =-0.4mA	3.0 to 5.5	V _{DD} -0.4			
	V _{OH} (5)		I _{OH} =-0.2mA	2.2 to 5.5	V _{DD} -0.4			
	V _{OH} (6)	PWM2, PWM3	I _{OH} =-10mA	4.5 to 5.5	V _{DD} -1.5			
	V _{OH} (7)		I _{OH} =-1.6mA	3.0 to 5.5	V _{DD} -0.4			V
	V _{OH} (8)		I _{OH} =-1mA	2.2 to 5.5	V _{DD} -0.4			
Low level output	V _{OL} (1)	Ports 0, 1, 2	I _{OL} =10mA	4.5 to 5.5			1.5	
voltage	V _{OL} (2)	Ports 3, C	I _{OL} =1.6mA	3.0 to 5.5			0.4	
	V _{OL} (3)	PWM2, PWM3,	I _{OL} =1mA	2.2 to 5.5			0.4	
	V _{OL} (4)	Ports 7, 8	I _{OL} =1.6mA	3.0 to 5.5			0.4	
	V _{OL} (5)	XT2	I _{OL} =1mA	2.2 to 5.5			0.4	
	V _{OL} (6)	P00, P01	I _{OL} =30mA	4.5 to 5.5			1.5	
	V _{OL} (7)		I _{OL} =5mA	3.0 to 5.5			0.4	
	V _{OL} (8)		I _{OL} =2.5mA	2.2 to 5.5			0.4	
Pull-up resistance	Rpu(1)	Ports 0, 1, 2, 7	V _{OH} =0.9V _{DD}	4.5 to 5.5	15	35	80	kΩ
	Rpu(2)	Ports 3, C		2.2 to 5.5	18	35	150	11.22
Hysteresis voltage	VHYS	RES Ports 1, 2, 7		2.2to 5.5		0.1V _{DD}		V
Pin capacitance	СР	All pins	For pins other than that under test: V _{IN} =V _{SS} f=1MHz Ta=25°C	2.2 to 5.5		10		pF

Serial I/O Characteristics at $Ta=-40^{\circ}C$ to $+85^{\circ}C,~V_{SS}1=V_{SS}2=V_{SS}3=0V$

1. SIO0 Serial I/O Characteristics (Note 4-1-1)

Parameter		aramotor	Symbol	Pins	Conditions			Spec	ification	
	г	arameter	Symbol	/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit
		Frequency	tSCK(1)	SCK0(P12)	• See Fig. 6.		2			
	~	Low level pulse width	tSCKL(1)				1			
	Input clock	High level pulse width	tSCKH(1)	-		2.2 to 5.5	1			
clock	n		tSCKHA(1)		Continuous data transmission/reception mode See Fig. 6. (Note 4-1-2)		4			tCYC
Serial clock		Frequency	tSCK(2)	SCK0(P12)	CMOS output selected See Fig. 6.		4/3			
	ck	Low level pulse width	tSCKL(2)	-			1/2			tSCK
	Output clock	High level pulse width	tSCKH(2)			2.2 to 5.5	2.2 to 5.5		1/2	
	nO		tSCKHA(2)		Continuous data transmission/reception mode CMOS output selected See Fig. 6.		tSCKH(2) +2tCYC		tSCKH(2) +(10/3) tCYC	tCYC
Serial input	Da	ta setup time	tsDI(1)	SB0(P11), SI0(P11)	Must be specified with respect to rising edge of SIOCLK See fig. 6.	2.2 to 5.5	0.03			
Serial	Da	ta hold time	thDI(1)			2.2 to 5.5	0.03			
	clock	Output delay time	tdD0(1)	SO0(P10), SB0(P11),	Continuous data transmission/reception mode (Note 4-1-3)	2.2 to 5.5			(1/3)tCYC +0.05	
output	rutput Input clock		tdD0(2)		Synchronous 8-bit mode (Note 4-1-3)	2.2 to 5.5			1tCYC +0.05	μs
Serial output	Output clock		tdD0(3)		• (Note 4-1-3)	2.2 to 5.5			(1/3)tCYC +0.15	

Note 4-1-1: These specifications are theoretical values. Add margin depending on its use.

Note 4-1-2: To use serial-clock-input in continuous trans/rec mode, a time from SI0RUN being set when serial clock is "H" to the first negative edge of the serial clock must be longer than tSCKHA.

Note 4-1-3: Must be specified with respect to falling edge of SIOCLK. Must be specified as the time to the beginning of output state change in open drain output mode. See Fig. 6.

2. SIO1 Serial I/O Characteristics (Note 4-2-1)

	_		O:bl	Pins/	O and distance			Spec	ification	
	Р	arameter	Symbol	Remarks	Conditions	V _{DD} [V]	min	typ	max	unit
	ĸ	Frequency	tSCK(3)	SCK1(P15)	• See Fig. 6.		2			
	Input clock	Low level pulse width	tSCKL(3)			2.2 to 5.5	1]
clock	lul	High level pulse width	tSCKH(3)				1			tCYC
Serial clock	ck	Frequency	tSCK(4)	SCK1(P15)	CMOS output selected. See Fig. 6.		2			
	Output clock	Low level pulse width	tSCKL(4)			2.2 to 5.5		1/2		10014
	On	High level pulse width	tSCKH(4)					1/2		tSCK
input	Da	ta setup time tsDI(2) SB1(P14), SI1(P14)		` ''	Must be specified with respect to rising edge of SIOCLK. See fig. 6.		0.03			
Serial input	Da	ta hold time	thDI(2)			2.2 to 5.5	0.03			
Serial output	Output delay time		tdD0(4)	SO1(P13), SB1(P14)	Must be specified with respect to falling edge of SIOCLK. Must be specified as the time to the beginning of output state change in open drain output mode. See Fig. 6.	2.2 to 5.5			(1/3)tCYC +0.05	, µs

Note 4-2-1: These specifications are theoretical values. Add margin depending on its use.

Pulse Input Conditions at Ta = -40°C to +85°C, $V_SS1 = V_SS2 = V_SS3 = 0V$

Parameter	Oh. al	Pins/Remarks	Conditions			Speci	fication	
Parameter	Symbol	Pins/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit
High/low level	tPIH(1)	INT0(P70),	Interrupt source flag can be set.					
pulse width	tPIL(1)	INT1(P71),	Event inputs for timer 0 or 1 are					
		INT2(P72),	enabled.					
		INT4(P20 to P23),		2.2 to 5.5	1			
		INT5(P24 to P27),						
		INT6(P20),						
		INT7(P24)						tCYC
	tPIH(2)	INT3(P73) when noise filter	Interrupt source flag can be set.	2.2 to 5.5	2			
	tPIL(2)	time constant is 1/1.	Event inputs for timer 0 are enabled.	2.2 10 5.5	2			
	tPIH(3)	INT3(P73) when noise filter	Interrupt source flag can be set.	2.2 to 5.5	64			
	tPIL(3)	time constant is 1/32	Event inputs for timer 0 are enabled.	2.2 10 5.5	64			
	tPIH(4)	INT3(P73) when noise filter	Interrupt source flag can be set.	2240 5 5	256			
	tPIL(4)	time constant is 1/128	Event inputs for timer 0 are enabled.	2.2 to 5.5	256			
	tPIL(5)	RES	Resetting is enabled.	2.2 to 5.5	200			μs

AD Converter Characteristics at $Ta = -40^{\circ}C$ to $+85^{\circ}C$, $V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

Parameter	0 1 1	D' /D 1	0 - 177		Specification					
	Symbol	Pins/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit		
Resolution	N	AN0(P80) to		3.0 to 5.5		8		bit		
Absolute accuracy	ET	AN6(P86), AN8(P70),	(Note 6-1)	3.0 to 5.5			±1.5	LSB		
Conversion time	TCAD	TCAD AN9(P71), AN10(XT1), AN11(XT2)	AD conversion time=32×tCYC (when ADCR2=0) (Note 6-2)	4.5 to 5.5	11.74 (tCYC= 0.367μs)		97.92 (tCYC= 3.06μs)			
				3.0 to 5.5	23.53 (tCYC= 0.735μs)		97.92 (tCYC= 3.06μs)			
		AD conversion time=64×tCYC (when ADCR2=1) (Note 6-2)	4.5 to 5.5	15.68 (tCYC= 0.245μs)		97.92 (tCYC= 1.53μs)	μs			
				3.0 to 5.5	23.49 (tCYC= 0.367μs)		97.92 (tCYC= 1.53μs)			
Analog input voltage range	VAIN			3.0 to 5.5	V _{SS}		V _{DD}	٧		
Analog port	IAINH		VAIN=V _{DD}	3.0 to 5.5	_		1	4		
input current	IAINL		VAIN=V _{SS}	3.0 to 5.5	-1		_	μΑ		

Note 6-1: The quantization error ($\pm 1/2$ LSB) is excluded from the absolute accuracy value.

Note 6-2: The conversion time refers to the interval from the time the instruction for starting the converter is issued till the time the complete digital value corresponding to the analog input value is loaded in the required register.

 $\textbf{Consumption Current Characteristics} \ \, at \ \, Ta = -40^{\circ}C \ \, to \ \, +85^{\circ}C, \ \, V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

Danamatan	0	Dia - /D	Condition -		5	Specifi	cation	
Parameter	Symbol	Pins/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit
Normal mode consumption current (Note 7-1)	IDDOP(1)	V _{DD} 1 =V _{DD} 2 =V _{DD} 3	FmCF=12MHz ceramic oscillation mode FmX'tal=32.768kHz by crystal oscillation mode System clock set to 12MHz side	4.5 to 5.5		9.1	18.5	
(Note 7 1)			Internal RC oscillation stopped frequency variable RC oscillation stopped 1/1 frequency division ratio.	2.8 to 4.5		5.3	13.5	
	IDDOP(2)		FmCF=8MHz ceramic oscillation mode FmX'tal=32.768kHz by crystal oscillation mode System clock set to 8MHz side	4.5 to 5.5		6.7	14	
	IDDOP(3)		Internal RC oscillation stopped frequency variable RC oscillation stopped 1/1 frequency division ratio.	2.5 to 4.5		3.8	10	
	IDDOP(4)		FmCF=4MHz ceramic oscillation mode FmX'tal=32.768kHz by crystal oscillation mode System clock set to 4MHz side	4.5 to 5.5		2.7	6	mA
	IDDOP(5)		Internal RC oscillation stopped frequency variable RC oscillation stopped 1/2 frequency division ratio.	2.2 to 4.5		1.45	3.8	
	IDDOP(6)		FmCF=0Hz (oscillation stopped) FmX'tal=32.768kHz by crystal oscillation mode	4.5 to 5.5		0.95	4.3	
	IDDOP(7)		System clock set to internal RC oscillation frequency variable RC oscillation stopped 1/2 frequency division ratio.	2.2 to 4.5		0.53	3.0	
	IDDOP(8)		FmCF=0Hz (oscillation stopped) FmX'tal=32.768kHz by crystal oscillation mode. Science clock cost to 4MHz with frequency.	4.5 to 5.5		1.25	5.2	
	IDDOP(9)		System clock set to 1MHz with frequency variable RC oscillation Internal RC oscillation stopped 1/2 frequency division ratio.	2.2 to 4.5		0.67	4.2	
	IDDOP(10)		FmCF=0Hz (oscillation stopped) FmX'tal=32.768kHz by crystal oscillation mode.	4.5 to 5.5		38	110	
	IDDOP(11)		System clock set to 32.768kHz side. Internal RC oscillation stopped frequency variable RC oscillation stopped 1/2 frequency division ratio.	2.2 to 4.5		19	70	μА
HALT mode consumption current (Note 7-1)	IDDHALT(1)	V _{DD} 1 =V _{DD} 2 =V _{DD} 3	HALT mode FmCF=12MHz ceramic oscillation mode FmX'tal=32.768kHz by crystal oscillation mode	4.5 to 5.5		3.2	7.5	
(vote : · ·)			System clock set to 12MHz side Internal RC oscillation stopped frequency variable RC oscillation stopped 1/1 frequency division ratio.	2.8 to 5.5		1.8	4	
	IDDHALT(2)		HALT mode FmCF=8MHz ceramic oscillation mode FmX'tal=32.768kHz by crystal oscillation mode	4.5 to 5.5		2.4	5.3	mA
	IDDHALT(3)		System clock set to 8MHz side Internal RC oscillation stopped frequency variable RC oscillation stopped 1/1 frequency division ratio.	2.5 to 4.5		12.5	2.8	

Note 7-1: The consumption current value includes none of the currents that flow into the output Tr and internal pull-up resistors

Continued on next page.

Continued from preceding page.

Parameter	Symbol	Pins/Remarks	Conditions		Specification					
Farameter	Symbol	FIIIS/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit		
HALT mode consumption current (Note 7-1)	IDDHALT(4)	V _{DD} 1 =V _{DD} 2 =V _{DD} 3	HALT mode FmCF=4MHz ceramic oscillation mode FmX'tal=32.768kHz by crystal oscillation mode	4.5 to 5.5		1	2.3			
	IDDHALT(5)		System clock set to 4MHz side Internal RC oscillation stopped frequency variable RC oscillation stopped 1/2 frequency division ratio.	2.2 to 4.5		0.5	1.3			
	IDDHALT(6)		HALT mode FmCF=0Hz (oscillation stopped) FmX'tal=32.768kHz by crystal oscillation mode	4.5 to 5.5		0.33	0.9	mA		
	IDDHALT(7)		System clock set to internal RC oscillation frequency variable RC oscillation stopped 1/2 frequency division ratio.	2.2 to 4.5		0.17	0.7	IIIA		
	IDDHALT(8)		HALT mode FmCF=0Hz (oscillation stopped) FmX'tal=32.768kHz by crystal oscillation mode.	4.5 to 5.5		1	3.8			
	IDDHALT(9)		System clock set to 1MHz with frequency variable RC oscillation Internal RC oscillation stopped 1/2 frequency division ratio.	2.2 to 4.5		0.5	2.7			
	IDDHALT(10)		HALT mode FmCF=0Hz (oscillation stopped) FmX'tal=32.768kHz by crystal oscillation mode.	4.5 to 5.5		18	70			
	IDDHALT(11)		System clock set to 32.768kHz side. Internal RC oscillation stopped frequency variable RC oscillation stopped 1/2 frequency division ratio.	2.2 to 4.5		5	63	μА		
HOLD mode	IDDHOLD(1)	V _{DD} 1	HOLD mode	4.5 to 5.5		0.03	18			
consumption current	IDDHOLD(2)		CF1=V _{DD} or open (External clock mode)	2.2 to 4.5		0.01	14			
Timer HOLD mode	IDDHOLD(3)		Timer HOLD mode CF1=VDD or open (External clock mode)	4.5 to 5.5		16	63			
consumption current	IDDHOLD(4)		FmX'tal=32.768kHz by crystal oscillation mode	2.2 to 4.5		3.5	50			

Note 7-1: The consumption current value includes none of the currents that flow into the output Tr and internal pull-up resistors

F-ROM Programming Characteristics at $Ta = +10^{\circ}C$ to $+55^{\circ}C$, $V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

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Parameter	O make at	D' /D 1	Conditions		Specification					
	Symbol	Pins/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit		
Onboard programming	IDDFW(1)	V _{DD} 1	Without CPU current	2.7 to 5.5		5	10	mA		
current Programming	tFW(1)		Erasing	2.7 to 5.5		20	30	ms		
time	tFW(2)		• programming	2.7 to 5.5		40	60	μs		

UART (Full Duplex) Operating Conditions at Ta = -40°C to +85°C, $V_{SS}1 = V_{SS}2 = V_{SS}3 = 0$ V

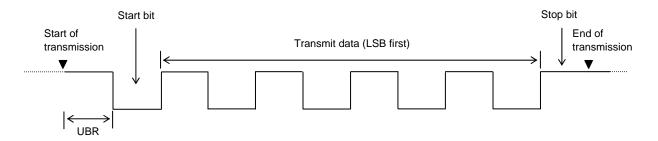
Danamatan	O. made al.	Dia - /D	O a maliation o		Specification				
Parameter	Symbol	Pins/Remarks	Conditions	V _{DD} [V]	min	typ	max	unit	
Transfer rate	UBR	P32 (UTX1),							
		P33 (URX1),		2.5 to 5.5	16/0		8192/3	tCYC	
		P34 (UTX2),		2.5 10 5.5	16/3		0192/3	icrc	
		P35 (URX2)							

Data length: 7, 8, and 9 bits (LSB first)

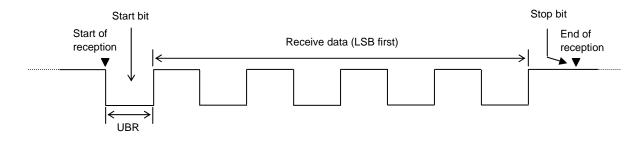
Stop bits : 1-bit (2-bit in continuous data transmission)

Parity bits : None

Example of Continuous 8-bit Data Transmission Mode Processing (First Transmit Data = 55H)



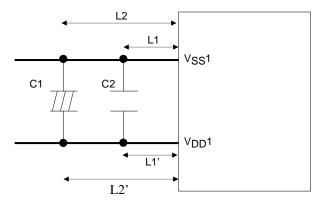
Example of Continuous 8-bit Data Reception Mode Processing (First Receive Data = 55H)



VDD1, VSS1 Terminal Condition

It is necessary to place capacitors between $V_{\mbox{DD}}1$ and $V_{\mbox{SS}}1$ as describe below.

- Place capacitors as close to V_{DD}1 and V_{SS}1 as possible.
- Place capacitors so that the length of each terminal to the each leg of the capacitor be equal (L1 = L1', L2 = L2').
- Place high capacitance capacitor C1 and low capacitance capacitor C2 in parallel.
- \bullet Capacitance of C2 must be more than 0.1 $\mu F.$
- \bullet Use thicker pattern for $V_{\mbox{\scriptsize DD}}1$ and $V_{\mbox{\scriptsize SS}}1.$



Characteristics of a Sample Main System Clock Oscillation Circuit

Given below are the characteristics of a sample main system clock oscillation circuit that are measured using a Our designated oscillation characteristics evaluation board and external components with circuit constant values with which the oscillator vendor confirmed normal and stable oscillation.

Table 1 Characteristics of a Sample Main System Clock Oscillator Circuit with a Ceramic Oscillator

Nominal Vendor		O a illustra Na a a	Circuit Constant				Operating Voltage	Oscillation Stabilization Time		Damada	
Frequency	Name	Oscillator Name	C1	C2	Rf1	Rd1	Range	typ	max	Remarks	
			[pF]	[pF]	[Ω]	[Ω]	[V]	[ms]	[ms]		
12MHz		CSTCE12M0G52-R0	(10)	(10)	Open	470	2.6 to 5.5	0.03	0.5	Internal C1,C2	
400411-		CSTCE10M0G52-R0	(10)	(10)	Open	470	2.4 to 5.5	0.03	0.5	Internal C1,C2	
10MHz	MURATA	CSTLS10M0G53-B0	(15)	(15)	Open	680	2.6 to 5.5	0.03	0.5	Internal C1,C2	
ONAL I-		CSTCE8M00G52-R0	(10)	(10)	Open	680	2.3 to 5.5	0.03	0.5	Internal C1,C2	
8MHz		CSTLS8M00G53-B0	(15)	(15)	Open	1k	2.5 to 5.5	0.03	0.5	Internal C1,C2	
4MHz		CSTCR4M00G53-R0	(15)	(15)	Open	1.5k	2.2 to 5.5	0.03	0.5	Internal C1,C2	
		CSTLS4M00G53-B0	(15)	(15)	Open	1.5k	2.2 to 5.5	0.03	0.5	Internal C1,C2	

The oscillation stabilization time refers to the time interval that is required for the oscillation to get stabilized after V_{DD} goes above the operating voltage lower limit (see Fig. 4).

Characteristics of a Sample Subsystem Clock Oscillator Circuit

Given below are the characteristics of a sample subsystem clock oscillation circuit that are measured using a Our designated oscillation characteristics evaluation board and external components with circuit constant values with which the oscillator vendor confirmed normal and stable oscillation.

Table 2 Characteristics of a Sample Subsystem Clock Oscillator Circuit with a Crystal Oscillator

Nominal	Vendor	Ossillatas Nassa	Circuit Constant			Operating Voltage	Oscillation Stabilization Time		Pomorko	
Frequency Name	Oscillator Name	C3 [pF]	C4 [pF]	Rf2 [Ω]	Rd2 [Ω]	Range [V]	typ [s]	max [s]	Remarks	
32.768kHz	EPSON TOYOCOM	MC-306	18	18	Open	560k	2.2 to 5.5	1.2	3.0	Applicable CL value=12.5pF

The oscillation stabilization time refers to the time interval that is required for the oscillation to get stabilized after the instruction for starting the subclock oscillation circuit is executed and to the time interval that is required for the oscillation to get stabilized after the HOLD mode is reset (see Figure. 4).

Note: The components that are involved in oscillation should be placed as close to the IC and to one another as possible because they are vulnerable to the influences of the circuit pattern.

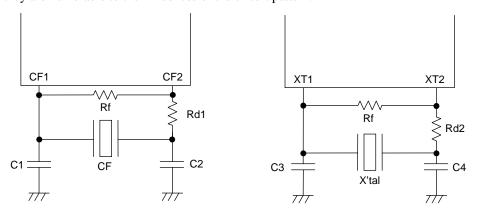
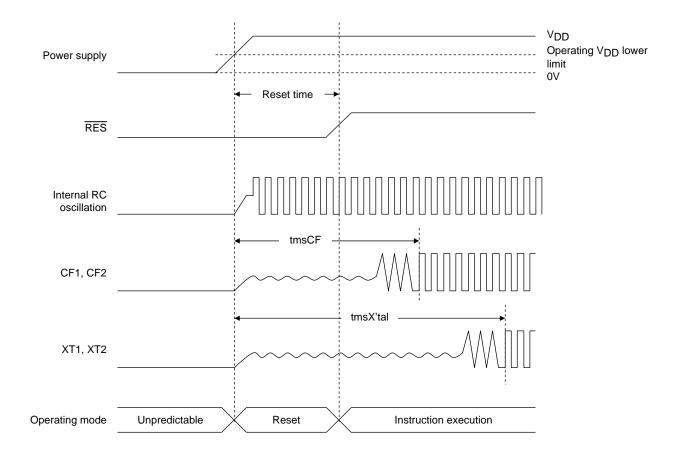


Figure 1 CF Oscillator Circuit

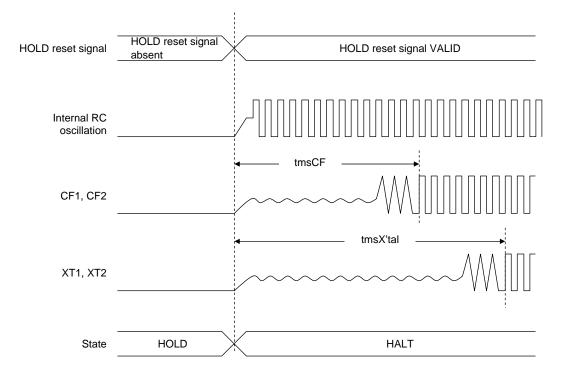
Figure 2 XT Oscillator Circuit



Figure 3 AC Timing Measurement Point

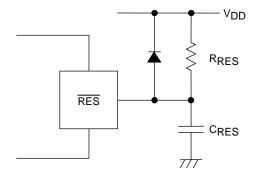


Reset Time and Oscillation Stabilization Time



HOLD Release Signal and Oscillation Stabilization Time

Figure 4 Oscillation Stabilization Times



Note:

Determine the value of CRES and RRES so that the reset signal is present for a period of $200\mu s$ after the supply voltage goes beyond the lower limit of the IC's operating voltage.

Figure 5 Reset Circuit

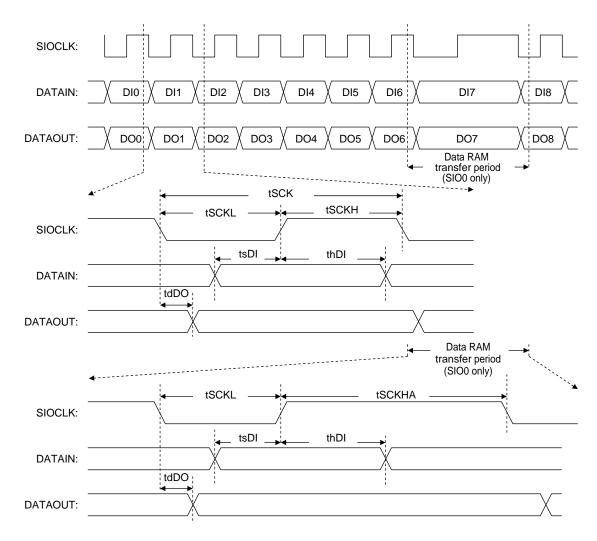


Figure 6 Serial I/O Waveforms

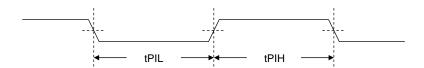


Figure 7 Pulse Input Timing Signal Waveform

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